



正基科技股份有限公司

SPECIFICATION

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NAME				



AMPAK

AP6330

WiFi+Bluetooth 4.0(HS)+FM Rx Module Spec Sheet



Revision History

Date	Revision Content	Revised By	Version
2012/10/01	- Preliminary	Bart	1.0
2012/12/26	- Modify Pin name 29,30	Brian	1.1
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1. Introduction

AMPAK Technology would like to announce a low-cost and low-power consumption module which has all of the WiFi, Bluetooth and FM functionalities. The highly integrated module makes the possibilities of web browsing, VoIP, Bluetooth headsets, FM radio functional applications and other applications. With seamless roaming capabilities and advanced security, also could interact with different vendors' 802.11a/b/g/n Access Points in the wireless LAN.

The wireless module complies with IEEE 802.11 a/b/g/n standard and it can achieve up to a speed of 72.2Mbps with single stream in 802.11n draft, 54Mbps as specified in IEEE 802.11g, or 11Mbps for IEEE 802.11b to connect to the wireless LAN. The integrated module provides SDIO interface for WiFi, UART / PCM interface for Bluetooth FM.

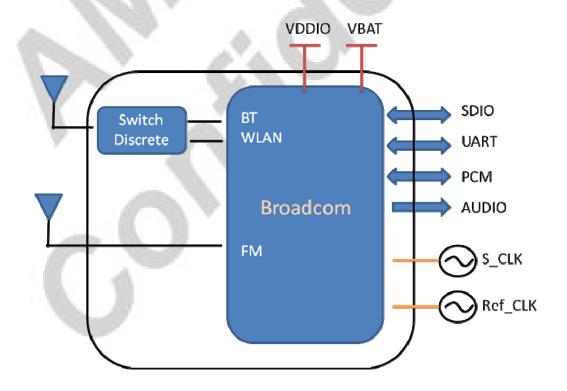
This compact module is a total solution for a combination of WiFi + BT + FM technologies. The module is specifically developed for Smart phones and Portable devices.



2. Features

- 802.11a/b/g/n dual-band radio non-simultaneous dual-band operation
- Bluetooth V4.0(HS) with integrated Class 1 PA and Low Energy (BLE) support
- Concurrent Bluetooth, FM (RX) RDS/RBDS, and WLAN operation
- Simultaneous BT/WLAN receive with single antenna
- WLAN host interface options:
 - SDIO v2.0 up to 50 MHz clock rate
- BT host digital interface:
 - UART (up to 4 Mbps)
- FM multiple audio routing options: PCM, eSCO, A2DP
- IEEE Co-existence technologies are integrated die solution
- ECI enhanced coexistence support, ability to coordinate BT SCO transmissions around WLAN receives

A simplified block diagram of the module is depicted in the figure below.





3. Deliverables

3.1 Deliverables

The following products and software will be part of the product.

- Module with packaging
- **Evaluation Kits**
- Software utility for integration, performance test.
- Product Datasheet.
- Agency certified pre-tested report with the adapter board.

3.2 Regulatory certifications

The product delivery is a pre-tested module, without the module level certification. For module approval, the platform's antennas are required for the certification.



4. General Specification

4.1 General Specification

Model Name	AP6330			
Product Description	Support WiFi/Bluetooth/FM functionalities			
Dimension	x W x H: 12 x 12 x 1.5 (typical) mm			
WiFi Interface	SDIOV2.0			
BT Interface	UART / PCM			
FM Interface	UART / PCM / Audio			
Operating temperature	-30°C to 85°C			
Storage temperature	-40°C to 85°C			
Humidity	Operating Humidity 10% to 95% Non-Condensing			

4.2 Voltages

4.2.1 Absolute Maximum Ratings

Symbol	Description	Min.	Max.	Unit
VBAT	Input supply Voltage	-0.5	6	V
VDDIO	Digital/Bluetooth/SDIO/ I/O Voltage	-0.5	2.98	V

4.2.2 Recommended Operating Rating

The module requires two power supplies: VBAT and VDDIO.

	Min.	Тур.	Max.	Unit
Operating Temperature	-30	25	85	deg.C
VBAT	3.0	3.6	4.8	V
VDDIO	1.2	1.8	2.9+/-3%	V



5. WiFi RF Specification

5.1 2.4GHz & 5GHz RF Specification

Conditions: VBAT=3.6V; VDDIO=2.9V; Temp:25°C

Feature	Description			
WLAN Standard	IEEE 802.11a/b/g/n, WiFi compliant			
Frequency Range	2.400 GHz ~ 2.497 GHz (2.4 GHz ISM Band)			
i requericy italige	4.900 GHz ~ 5.845 GHz (5.0 GHz ISM Band)			
Number of Channels	2.4GHz: Ch1 ~ Ch14			
Number of Orialines	5.0GHz: Please see the table ¹			
	802.11a : OFDM /64-QAM,16-QAM, QPSK, BPSK			
Modulation	802.11b : DQPSK, DBPSK, CCK			
	802.11 g/n : OFDM /64-QAM,16-QAM, QPSK, BPSK			
A 7	802.11a /54Mbps : 13 dBm ± 1.5 dB @ EVM ≤ -25dB			
Output Power	802.11b /11Mbps : 16 dBm \pm 1.5 dB @ EVM \leq -9dB			
Output i owei	802.11g /54Mbps : 15 dBm ± 1.5 dB @ EVM ≤ -25dB			
18.00	802.11n /65Mbps : 14 dBm \pm 1.5 dB @ EVM \leq -28dB			
	- MCS=0 PER @ -89 dBm, typical			
	- MCS=1 PER @ -85 dBm, typical			
	- MCS=2 PER @ -84 dBm, typical			
Receive Sensitivity (11n,20MHz)	- MCS=3 PER @ -80 dBm, typical			
@10% PER	- MCS=4 PER @ -77 dBm, typical			
@ 10 /0 1 LIX	- MCS=5 PER @ -75 dBm, typical			
	- MCS=6 PER @ -72 dBm, typical			
	- MCS=7 PER @ -71 dBm, typical			
	- 6Mbps PER @ -90 dBm, typical			
	- 9Mbps PER @ -88 dBm, typical			
	- 12Mbps PER @ -87 dBm, typical			
Receive Sensitivity (11g)	- 18Mbps PER @ -85 dBm, typical			
@10% PER	- 24Mbps PER @ -83 dBm, typical			
	- 36Mbps PER @ -80 dBm, typical			
	- 48Mbps PER @ -76 dBm, typical			
	- 54Mbps PER @ -74 dBm, typical			
Deceive Constitute (441)	- 1Mbps PER @ -96 dBm, typical			
Receive Sensitivity (11b)	- 2Mbps PER @ -90 dBm, typical			
@8% PER				





	- 11Mbps PER @ -87 dBm, typical			
	- 6Mbps PER @ -81 dBm, typical			
	- 9Mbps PER @ -80 dBm, typical			
	- 12Mbps PER @ -79 dBm, typical			
Receive Sensitivity (11a)	- 18Mbps PER @ -77 dBm, typical			
@10% PER	- 24Mbps PER @ -76 dBm, typical			
	- 36Mbps PER @ -73 dBm, typical			
	- 48Mbps PER @ -69 dBm, typical			
	- 54Mbps PER @ -68 dBm, typical			
	802.11a : 6, 9, 12, 18, 24, 36, 48, 54Mbps			
Data Rate	802.11b : 1, 2, 5.5, 11Mbps			
	802.11g: 6, 9, 12, 18, 24, 36, 48, 54Mbps			
Data Rate (20MHz ,Long GI,800ns)	802.11n: 6.5, 13, 19.5, 26, 39, 52, 58.5, 65Mbps			
Data Rate (20MHz ,short GI,400ns)	802.11n : 7.2, 14.4, 21.7, 28.9, 43.3, 57.8, 65,72.2Mbps			
Maximum Input Level	802.11b : -10 dBm			
Maximum input Level	802.11a/g/n : -20 dBm			
Antenna Reference	Small antennas with 0~2 dBi peak gain			

¹5GHz Channel table

Band (GHz)	Operating Channel Channel center Numbers frequencies(MHz)		
70	36	5180	
5.15GHz~5.25GHz	40	5200	
5.15GHZ~5.25GHZ	44	5220	
	48	5240	
246	52	5260	
5.25GHz~5.35GHz	56	5280	
3.23GHZ 3.33GHZ	60	5300	
A 100 M	64	5320	
ATT TO	100	5500	
A A	104	5520	
UA. 100	108	5540	
VIA	112	5560	
	116	5580	
5.5GHz~5.7GHz	120	5600	
=	124	5620	
	128	5640	
	132	5660	
	136	5680	
	140	5700	
	149	5745	
5.725GHz~5.825GHz	153	5765	
3.723GHZ 3.023GHZ	157	5785	
	161	5805	



6. Bluetooth Specification

6.1 Bluetooth Specification

Conditions · VBAT=3 6V · VDDIO=2 9V · Temp·25°C

Feature	Description	Description				
General Specification	AL					
Bluetooth Standard	Bluetooth V4.0	Bluetooth V4.0 of 1, 2 and 3 Mbps.				
Host Interface	UART	UART				
Antenna Reference	Small antennas	s with 0~2 dBi peak	gain			
Frequency Band	2.400 GHz ~ 2	483.5 GHz	,			
Number of Channels	79 channels	79 channels				
Modulation	FHSS, GFSK,	FHSS, GFSK, DPSK, DQPSK				
RF Specification		V				
. 11.00	Min.	Typical.	Max.			
Output Power (Class 1.5)	12 P	10 dBm				
Output Power (Class 2)	100	2 dBm				
Sensitivity @ BER=0.1% for GFSK (1Mbps)		-86 dBm				
Sensitivity @ BER=0.01% for π/4-DQPSK (2Mbps)	100	-86 dBm				
Sensitivity @ BER=0.01% for 8DPSK (3Mbps)	4	-80 dBm				
	GFSK (1Mbps):-20dBm					
Maximum Input Level	π/4-DQPSK (2Mbps) :-20dBm					
	8DPSK (3Mbps) 00 ID				



7. FM Specification

7.1 FM Specification (TBD)

Conditions: VBAT=3.6V; VDDIO=2.9V; Temp:25°C

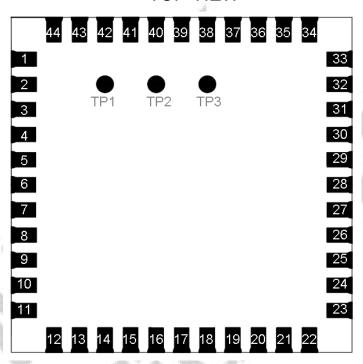
Feature	Description				1	w/
General Specification	A			100		
Frequency Band	76MHz-108MHz			4		
Host Interface	HCI UART, PCM					
Channel step	50 KHz		38	d		
Analog Audio output load	$R_L>30K\Omega$, $C_L>20pF$					
Characteristics	Condition		MIN	TYP	MAX	UNIT
.00	RDS Sensitivity	10				dBm
	Audio harmonic distortion	fmod= 1KHz			WAX	0/
Receiver	(Vin=1mV, \triangle f=75KHz)	fmod= 3KHz			%	
(FM Rx Antenna = 120nH, Q>30)	Maximum SNR	MONO				
1201111, Q230)	(fmod=1KHz, △f=22.5 KHz, BW=300Hz to 15KHz)	Stereo				dB
	RF input power level					dBuV



8. Pin Assignments

8.1 Pin Outline





8.2 Pin Definition

NO	Name	Туре	Description
1	GND	(h)	Ground connections
2	WL_BT_ANT	I/O	RF I/O port
3	GND	_	Ground connections
4	FM_RX	I	FM radio RF input antenna port
5	NC	_	Floating (Don't connected to ground)
6	BT_WAKE	I	HOST wake-up Bluetooth device
7	BT_HOST_WAKE	0	Bluetooth device to wake-up HOST
8	NC		Floating (Don't connected to ground)
9	VBAT	Р	Main power voltage source input
10	XTAL_IN	I	Crystal input
11	XTAL_OUT	0	Crystal output
12	WL_REG_ON	I	Internal regulators power enable/disable
13	WL_HOST_WAKE	0	WLAN to wake-up HOST

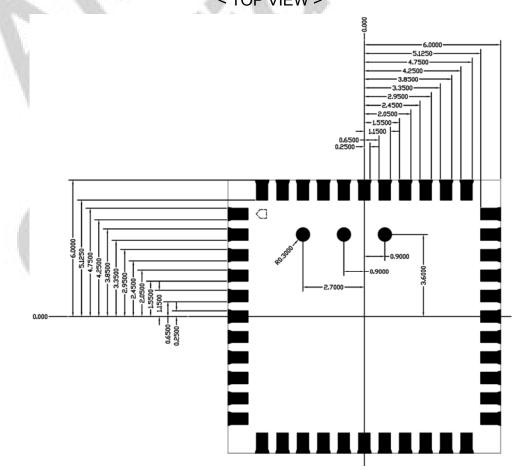


15 SDIO_DATA_3 I/O SDIO data line 3 16 SDIO_DATA_CMD I/O SDIO command line 17 SDIO_DATA_CLK I/O SDIO clock line 18 SDIO_DATA_0 I/O SDIO data line 0 19 SDIO_DATA_1 I/O SDIO data line 1 20 GND — Ground connections 21 VIN_LDO_OUT P Internal Buck voltage generation pin 22 VDDIO P I/O Voltage supply input 23 VIN_LDO P Internal Buck voltage generation pin 24 LPO I External Low Power Clock input (32,768KHz) 25 PCM_OUT I/O PCM data input 26 PCM_CLK I/O PCM data input 27 PCM_IN I/O PCM data input 28 PCM_SYNC I/O PCM sync signal 29 NC — Floating (Don't connected to ground) 30 NC — Floating (Don't connected to ground) 31 GND — Ground connections 32 NC — Floating (Don't connected to ground) 33 GND — Ground connections 34 BT_RST_N I Low asserting reset for Bluetooth core 35 NC — Floating (Don't connected to ground) 36 GND Ground connections 37 NC — Floating (Don't connected to ground) 38 NC — Floating (Don't connected to ground) 39 NC — Floating (Don't connected to ground) 40 NC — Floating (Don't connected to ground) 41 UART_RTS_N O Bluetooth/FM UART interface 42 UART_TXD O Bluetooth/FM UART interface 43 UART_RXD I Bluetooth/FM UART interface 44 UART_CTS_N I Bluetooth/FM UART interface 45 TP1 O FM Analog AUDIO right output 46 TP2 O FM Analog AUDIO right output 47 TP3 (NC) — Floating (Don't connected to ground)	14	SDIO_DATA_2	I/O	SDIO data line 2
16 SDIO_DATA_CMD I/O SDIO command line 17 SDIO_DATA_CLK I/O SDIO clock line 18 SDIO_DATA_O I/O SDIO data line 0 19 SDIO_DATA_1 I/O SDIO data line 1 20 GND — Ground connections 21 VIN_LDO_OUT P Internal Buck voltage generation pin 22 VDDIO P I/O Voltage supply input 23 VIN_LDO P Internal Buck voltage generation pin 24 LPO I External Low Power Clock input (32.768KHz) 25 PCM_OUT I/O PCM Data output 26 PCM_CLK I/O PCM data input 27 PCM_IN I/O PCM data input 28 PCM_SYNC I/O PCM sync signal 29 NC — Floating (Don't connected to ground) 30 NC — Floating (Don't connected to ground) 31 GND — Ground connections 32 NC Floating (Don't connected to ground) 33 GND — Ground connections 34 BT_RST_N I Low asserting reset for Bluetooth core 35 NC — Floating (Don't connected to ground) 36 GND — Ground connections 37 NC — Floating (Don't connected to ground) 38 NC — Floating (Don't connected to ground) 39 NC — Floating (Don't connected to ground) 40 NC — Floating (Don't connected to ground) 41 UART_RTS_N O Bluetooth/FM UART interface 42 UART_TXD O Bluetooth/FM UART interface 44 UART_CTS_N I Bluetooth/FM UART interface 45 TP1 O FM Analog AUDIO right output	h +			
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Second	33	GND	D.	Ground connections
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NC	35	NC	-4.	Floating (Don't connected to ground)
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40 NC — Floating (Don't connected to ground) 41 UART_RTS_N O Bluetooth/FM UART interface 42 UART_TXD O Bluetooth/FM UART interface 43 UART_RXD I Bluetooth/FM UART interface 44 UART_CTS_N I Bluetooth/FM UART interface 45 TP1 O FM Analog AUDIO left output 46 TP2 O FM Analog AUDIO right output	38	NC	V	Floating (Don't connected to ground)
41UART_RTS_NOBluetooth/FM UART interface42UART_TXDOBluetooth/FM UART interface43UART_RXDIBluetooth/FM UART interface44UART_CTS_NIBluetooth/FM UART interface45TP1OFM Analog AUDIO left output46TP2OFM Analog AUDIO right output	39	NC	W.	Floating (Don't connected to ground)
42 UART_TXD O Bluetooth/FM UART interface 43 UART_RXD I Bluetooth/FM UART interface 44 UART_CTS_N I Bluetooth/FM UART interface 45 TP1 O FM Analog AUDIO left output 46 TP2 O FM Analog AUDIO right output	40	NC	_	Floating (Don't connected to ground)
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44 UART_CTS_N I Bluetooth/FM UART interface 45 TP1 O FM Analog AUDIO left output 46 TP2 O FM Analog AUDIO right output	42	UART_TXD	0	Bluetooth/FM UART interface
45 TP1 O FM Analog AUDIO left output 46 TP2 O FM Analog AUDIO right output	43	UART_RXD	I	Bluetooth/FM UART interface
46 TP2 O FM Analog AUDIO right output	44	UART_CTS_N	I	Bluetooth/FM UART interface
	45	TP1	0	FM Analog AUDIO left output
47 TP3 (NC) Floating (Don't connected to ground)	46	TP2	0	FM Analog AUDIO right output
	47	TP3 (NC)	_	Floating (Don't connected to ground)



9. Dimensions

9.1 Physical Dimensions (Unit: mm) < TOP VIEW > < Side View > - 12 +/- 0.1 -12 +/- 0.1 1.5 +/- 0.1 < TOP VIEW >

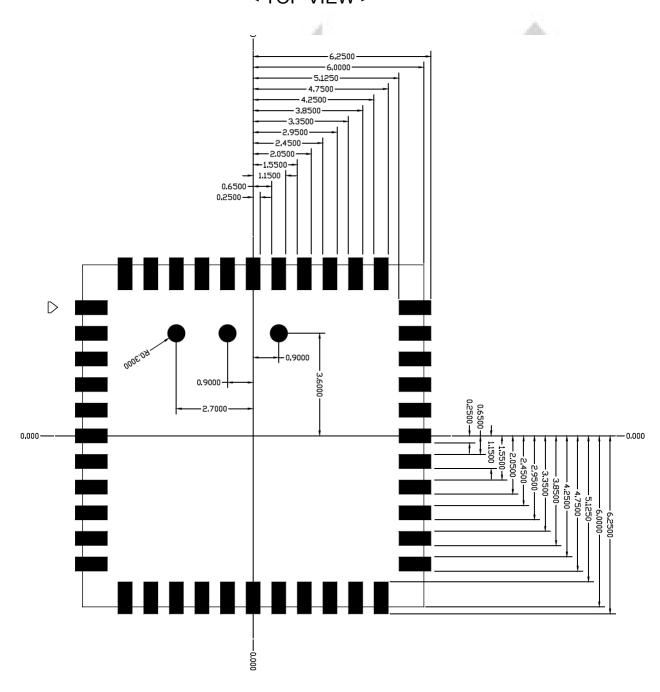




9.2 Layout Recommendation

(Unit: mm)

< TOP VIEW >





External clock reference

External LPO signal characteristics

Parameter	Specification	Units
Nominal input frequency	32.768	kHz
Frequency accuracy	±30	ppm
Duty cycle	30 - 70	%
Input signal amplitude	400 to 1800	mV, p-p
Signal type	Square-wave	B -
Input impodance	>100k	Ω
Input impedance	<5	pF
Clock jitter (integrated over 300Hz – 15KHz)	<1	Hz
Output high voltage	0.7Vio - Vio	V

External Ref CLK signal characteristics

Na	14	O. m. h	Electrical Specification				Barranda
No.	Item	Symb.	Min.	Туре	Max.	Units	Remark
1	Nominal Frequency	F0		26.00000		MHz	
2	Mode of Vibration			Funda	mental	•	
3	Frequency Tolerance	ΔF/F0	-10	-	10	ppm	at 25°C±3°C
4	Operating Temperature Range	Topr	-30	-	85	°C	
5	Frequency Stability	TC	-10	-	10	ppm	
6	Storage Temperature	T _{STG}	-55	-	125	$^{\circ}\!\mathbb{C}$	
7	Load capacitance	CL	-	16		pF	
8	Equivalent Series Resistance	ESR	-	-	50	Ω	
9	Drive Level	DL	-	100	200	μW	
10	Insulation Resistance	IR	500	-	-	ΜΩ	At 100V _{DC}
11	Shunt Capacitance	C0	-	-	3	pF	
12	Aging Per Year	Fa	-2	-	2	ppm	First Year

10.1 SDIO Pin Description

The module supports SDIO version 2.0 for 4-bit modes (100 Mbps), and high speed 4-bit (50 MHz clocks - 200 Mbps). It has the ability to stop the SDIO clock and map the interrupt signal into a GPIO pin. This 'out-of-band' interrupt signal notifies the host when the WLAN device wants to turn on the SDIO interface. The ability to force the control of the gated clocks from within the WLAN chip is also provided.



- Function 0 Standard SDIO function (Max BlockSize / ByteCount = 32B)
- ** Function 1 Backplane Function to access the internal System On Chip (SOC) address space (Max BlockSize / ByteCount = 64B)
- Function 2 WLAN Function for efficient WLAN packet transfer through DMA (Max BlockSize/ByteCount=512B)

SDIO Pin Description

SD 4-Bit Mode					
DATA0	Data Line 0				
DATA1	Data Line 1 or Interrupt				
DATA2	Data Line 2 or Read Wait				
DATA3	Data Line 3				
CLK	Clock				
CMD	Command Line				

Host Interface Timing Diagram

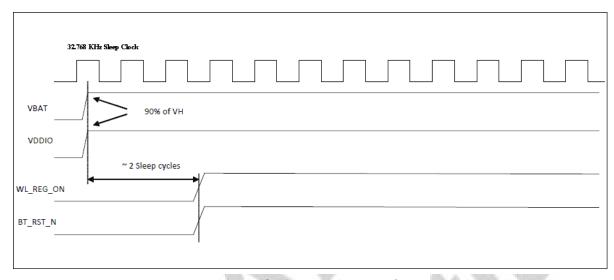
11.1 Power-up Sequence Timing Diagram

The module has signals that allow the host to control power consumption by enabling or disabling the Bluetooth, WLAN and internal regulator blocks. These signals are described below.

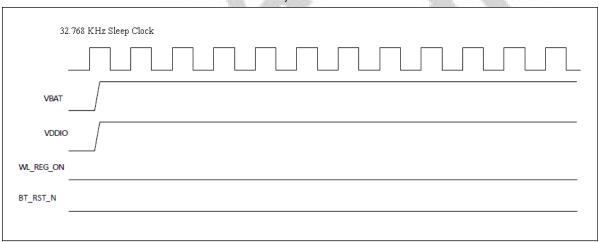
Additionally, diagrams are provided to indicate proper sequencing of the signals for carious operating states. The timing value indicated are minimum required values: longer delays are also acceptable.

- WL REG ON: Used by the PMU to power up the WLAN section. When this pin is high, the regulators are enabled and the WLAN section is out of reset. When this pin is low the WLAN section is in reset.
- BT RST N: Low asserting reset for Bluetooth and FM only. This pin has no effect on WLAN and does not control any PMU functions. This pin must be driven high or low (not left floating).

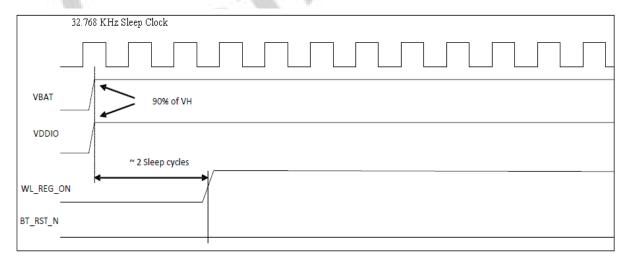




WLAN=ON, Bluetooth=ON

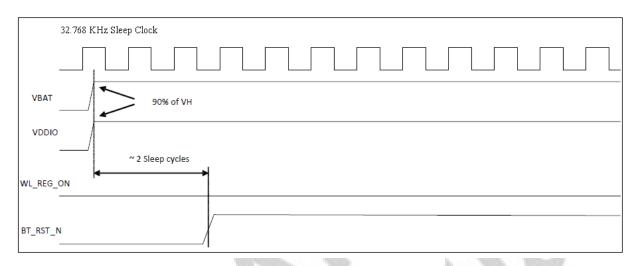


WLAN=OFF, Bluetooth=OFF



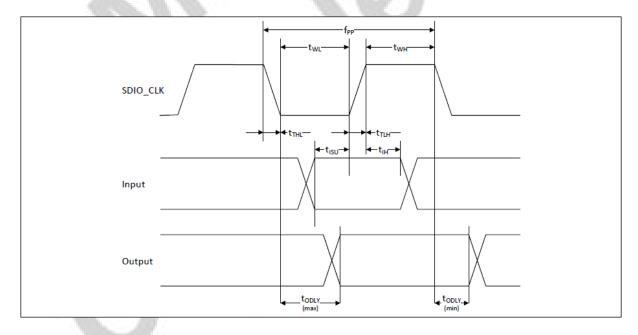
WLAN=ON, Bluetooth=OFF





WLAN=OFF, Bluetooth=ON

11.2 SDIO Default Mode Timing Diagram

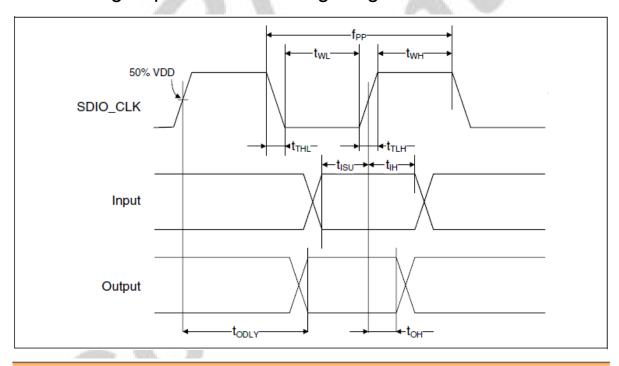




Parameter	Symbol	Minimum	Typical	Maximum	Unit
SDIO CLK (All values are refferred to mini	mum VIH and	d maximum VI	L ^b)		
Frequency-Data Transfer mode	fPP	0	-	25	MHz
Frequency-Identification mode	fOD	0	-	400	kHz
Clock low time	tWL	10	-	-	ns
Clock high time	tWH	10	-	-	ns
Clock rise time	tTLH	-	-	10	ns
Clock low time	tTHL	-	-	10	ns
Inputs: CMD, DAT (referenced to CLK)					
Input setup time	tISU	5	-	-	ns
Input hold time	tIH	5	-	-	ns
Outputs: CMD, DAT (referenced to CLK)					
Output delay time - Data Transfer mode	tODLY	0	-	14	ns
Output delay time - Identification mode	tODLY	0	-	50	ns

a. Timing is based on CL ≤ 40pF load on CMD and Data.

11.3 SDIO High Speed Mode Timing Diagram



Parameter	Symbol	Minimum	Typical	Maximum	Unit			
SDIO CLK (All values are refferred to minimum VIH and maximum VIL ^b)								
Frequency-Data Transfer mode	fPP	0	-	50	MHz			
Frequency-Identification mode	fOD	0	-	400	kHz			
Clock low time	tWL	7	-	-	ns			
Clock high time	tWH	7	-	-	ns			
Clock rise time	tTLH	-	-	3	ns			
Clock low time	tTHL	-	-	3	ns			
Inputs: CMD, DAT (referenced to CLK)								
Input setup time	tISU	6	-	-	ns			
Input hold time	tIH	2	-	-	ns			
Outputs: CMD, DAT (referenced to CLK)								
Output delay time - Data Transfer mode	tODLY	-	-	14	ns			
Output hold time	tOH	2.5	-	-	ns			
Total system capacitance (each line)	CL	-	-	40	pF			

a. Timing is based on CL \leq 40pF load on CMD and Data.

b. min(Vih) = 0.7 x VDDIO and max(ViI) = 0.2 x VDDIO.

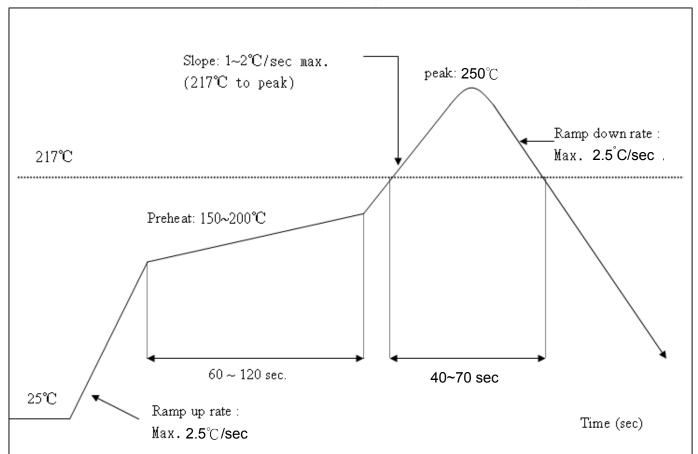
b. $min(Vih) = 0.7 \times VDDIO$ and $max(Vil) = 0.2 \times VDDIO$.



12. Recommended Reflow Profile

Referred to IPC/JEDEC standard.

Peak Temperature: <250°C Number of Times : ≤2 times





13. Package Information

13.1Label

Label A→ Anti-static and humidity notice



Label B→ MSL caution / Storage Condition

(Caution This bag contains MOISTURE-SENSITIVE DEVICES What has been adjacent bar code label.
1.	Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
2.	Peak package body temperature:*C
3.	After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be
	a) Mounted within: hours of factory conditions st blank, see adjacent bar code label ≤30°C/60% RH, or
	b) Stored per J-STD-033
4.	Devices require bake, before mounting, if:
	 a) Humidity Indicator Card reads >10% for level 2a - 5a devices or >60% for level 2 devices when read at 23 ± 5°C
	b) 3a or 3b are not met
5.	If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure
Ba	g Seal Date:
	Note: Level and body temperature defined by IPC/JEDEC J-STD-020

Label C→ Inner box label.

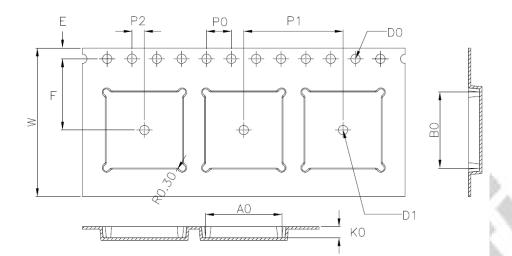
Model: P/N: 99P-W01-0048R Qty: Date Code :

Label D→ Carton box label .



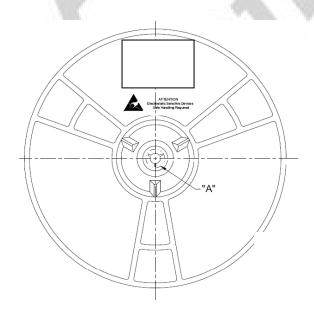


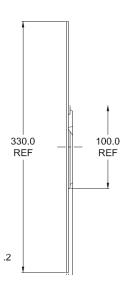
13.2 Dimension



W	24.00±0.30
A0	12.30±0.10
BO	12.30±0.10
K0	1.80±0.10
Ε	1.75±0.10
F	11.50±0.10
P0	4.00±0.10
P1	16.00±0.10
P2	2.00±0.10
DO	1.50 +0.10
D1	Ø1.50MIN

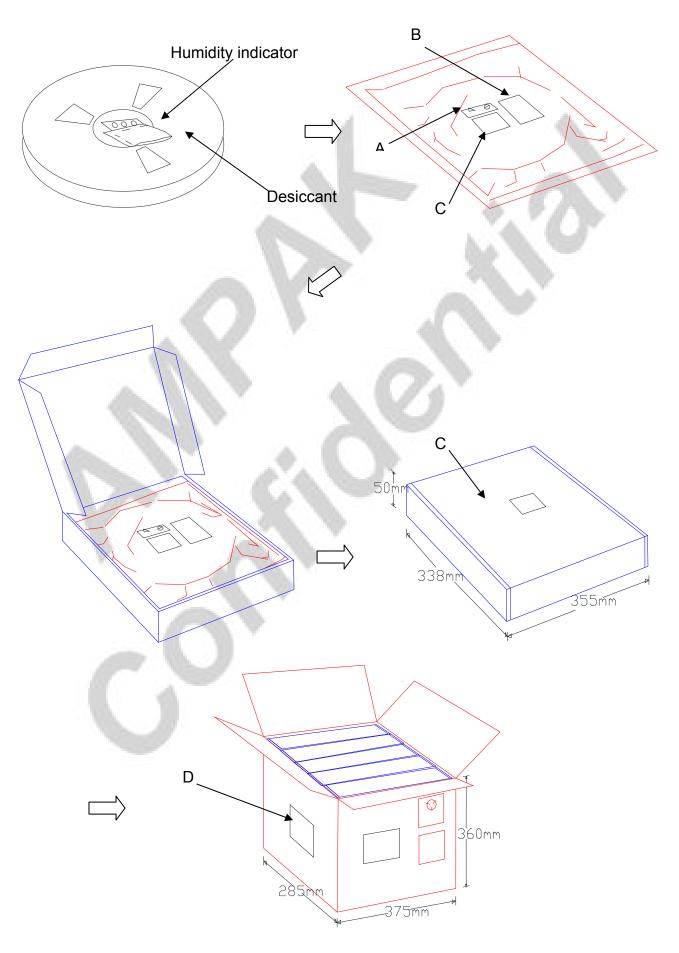
- 1. 10 sprocket hole pitch cumulative tolerance ± 0.20 .
- 2. Carrier camber is within 1 mm in 250 mm.
- 3. Material: Black Conductive Polystyrene Alloy.
- 4. All dimensions meet EIA-481-D requirements.
- 5. Thickness: 0.30±0.05mm.
- 6. Packing length per 22" reel: 98.5 Meters.(1:3)
- 7. Component load per 13" reel: 1500 pcs.













13.3 MSL Level / Storage Condition

LEVEL
Caution 1
This bag contains 4
MOISTURE-SENSITIVE DEVICES
Do not open except under controlled conditions
1. Calculated shelf life in sealed bag: 12 months at< 40° and
< 90% relative humidity(RH)
225°C 240°C 250°C 260°C
2. Peak package body temperature:
 After bag is opened, devices that will be subjected to reflow solder or other high temperature process must a) Mounted within: 48 hours of factory conditions <30°C/60% RH, OR b) Stored at <10% RH
 Devices require bake, before mounting, if: a)Humidity Indicator Card is>10%when read at 23±5℃ b)3a or 3b not met
5. If baking is required, devices may be baked for 24 hours at 125±5℃
Note: If device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure
Bag Seal Date: See-SEAL DATELABEL
Note:Level and body temperature defined by IPC/JEDED J-STD-020

※NOTE: Accumulated baking time should not exceed 96hrs